





SPECIFICATIONS

GENERAL

Contact Arrangement	4PDT (4 Form C)
Weight	3.0 oz approx.
Designed to meet the requirem	nents of MIL-PRF-83536

PERFORMANCE

Contact Rating (Note 1):

Resistive
(Case Grounded) Inductive
2.5 Amps @ 115/208V 60 Hz
(Case Grounded)
Motor4 Amps @ 28 VDC or
115/208V 400 Hz
(Case Grounded)
2 Amps @ 115/208V 60 Hz
(Case Grounded)
Lamp2 Amps @ 28 VDC or
115/208V 400 Hz
(Case Grounded)
1.5 Amps @ 115/208V 60 Hz
(Case Grounded)
Life
resistive load, 125°C
Pull In Power

Miniature 10 Amps • 4PDT To MIL-PRF-83536 DC Suppressed Coils

Operate/Release Time:	DC Coil 15 ms max		
Excluding bounce time at nominal coil volta			
Contact Bounce Time@ rated contact lo			
Contact Voltage Drop:			
Before Life	@ 10 Amps and 6 VDC		
After Life175 mv max (@ 10 Amps		
	and 6 VDC		
ENVIRONMENTAL			
Temperature Range	C to +125°C		
Vibration (Note 2)0.12" DA	10 - 70 Hz		
) - 3,000 Hz		
Shock (Operating)(Note 2)20	00 G's 6 ms		
ELECTRICAL CHARACTERISTICS			
Duty Cycle			

Continuous
100 megohms
@ 500V 25°C
-
1,250 VRMS
1,250 VRMS
1,000 VRMS
1,250 VRMS
350 VRMS

MIL-PRF-83536/16 QUALIFIED to ER level M

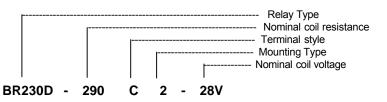
Notes

- 1. For other ratings consult the factory.
- 2. For applications requiring higher shock and vibration, consult the factory.



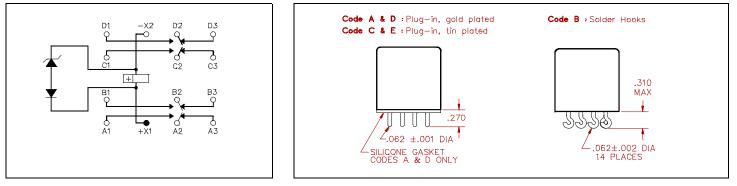
COIL DATA

MODEL BR230D PART NUMBER	BR230D-20()()-6V	BR230D-78()()-12V	BR230D-290()()-28V	BR230D-890()()-48V
NOMINAL COIL VOLTAGE	6 VDC	12 VDC	28 VDC	48 VDC
MAXIMUM COIL VOLTAGE	8 VDC	15 VDC	29 VDC	59 VDC
PULL IN VOLTAGE (MAX @ +125°C)	4.5 VDC	9 VDC	18 VDC	36 VDC
DROP OUT VOLTAGE (MAX)	1.8 VDC	3.5 VDC	5.1 VDC	11 VDC
MAXIMUM BACK EMF	9 VDC	18 VDC	42 VDC	72 VDC
COIL RESISTANCE ± 10% @ 25°C	20 OHMS	78 OHMS	290 OHMS	890 OHMS

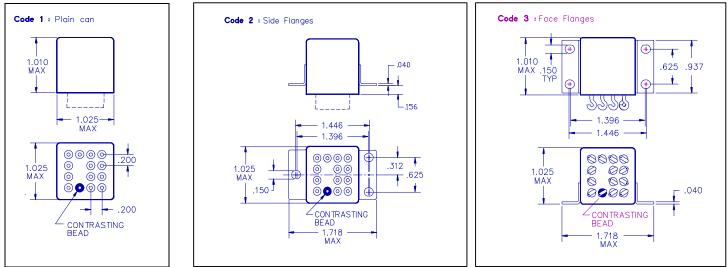


SCHEMATIC TERMINAL VIEWS

TERMINAL STYLES



MOUNTING CODES



GENERAL NOTES

- Unless otherwise specified, all tests made at nominal coil voltages, @ 25°C.
- For special coil variations, switching configurations, terminals styles and mounting types, consult the factory.
- Unless otherwise specified, tolerances on decimal dimensions are ± .010".
- Specifications contained herein are subject to change without notice.



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